

## 1-10 Clock Buffer for Networking Applications

### Features

- High Frequency >150 MHz
- High-speed, low-noise, non-inverting 1-10 buffer
- Low-skew (<150ps) between any two output clocks
- Low duty cycle distortion <300ps
- Low propagation delay <3.5ns
- Multiple V<sub>DD</sub>, GND pins for noise reduction
- 2.5V supply voltage and 3V tolerant input
- Packaging (Pb-free & Green available):
  - 20-pin SOIC (S)
  - 20-pin SSOP (H)
  - 20-pin QSOP (Q)

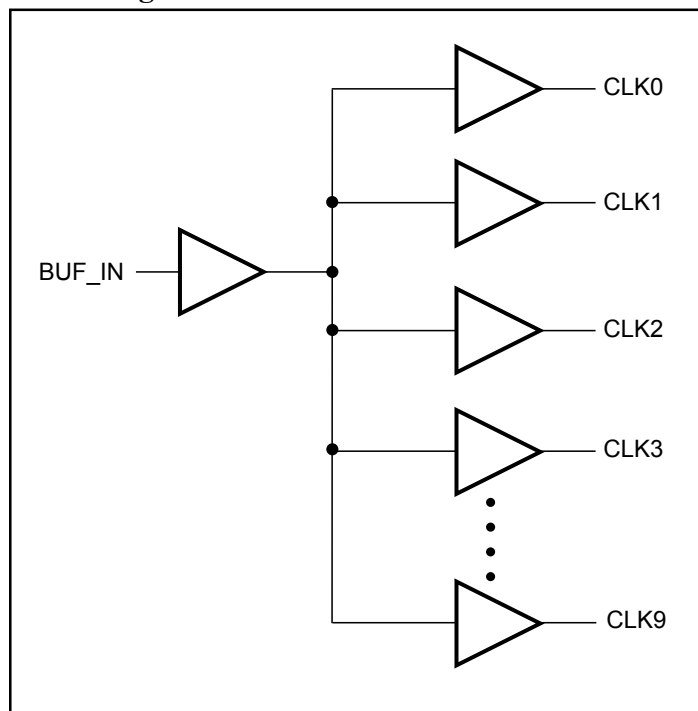
### Description

The PI49FCT20807, a 2.5V compatible, high-speed, low-noise 1-10 non-inverting clock buffer, is designed to target networking applications that require low-skew, low-jitter, and high-frequency clock distribution. Providing output-to-output skew as low as 150ps, the PI49FCT20807 is an ideal clock distribution device for synchronous systems. Designing synchronous networking systems requires a tight level of skew from a large number of outputs.

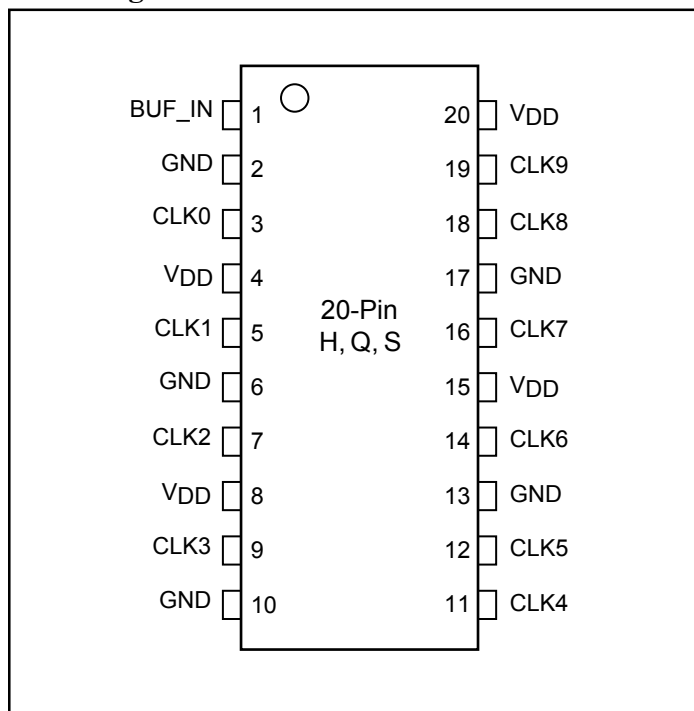
### Pin Description

Pin Name	Description
BUF_IN	Input
CLK [0:9]	Outputs
GND	Ground
V <sub>DD</sub>	Power

### Block Diagram



### Pin Configuration



### Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature.....	-65°C to +150°C
V <sub>DD</sub> Voltage.....	-0.5V to +3.6V
Input/Output Voltage <sup>(4)</sup> .....	-0.5V to V <sub>DD</sub> +0.5V
DC Output Current.....	-60mA to +60mA
Power Dissipation.....	.500mW

**Note:**

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

### Operating Range

V <sub>IN</sub> Voltage.....	-0.3V to 3.6V
V <sub>DD</sub> Voltage.....	2.5V ± 0.2V
Industrial Temperature.....	-40°C to +85°C
Input Frequency.....	DC to 30 MHz
Capacitive Loading.....	10pF to 25pF

### DC Electrical Characteristics (Over the Operating Range)

Parameters	Description	Test Conditions <sup>(1)</sup>	Min.	Typ. <sup>(2)</sup>	Max.	Units	
V <sub>IH</sub>	Input HIGH Voltage	Guaranteed Logic HIGH Level (Input Pins)	1.7	—		V	
V <sub>IL</sub>	Input LOW Voltage	Guaranteed Logic LOW Level (Input Pins)		—	0.7		
I <sub>I</sub>	Input Current	V <sub>DD</sub> = Max., V <sub>IN</sub> = V <sub>DD</sub> or GND		—	±1	mA	
V <sub>IK</sub>	Clamp Diode Voltage	V <sub>DD</sub> = Min., I <sub>IN</sub> = -18mA	—	-0.7	-1	V	
V <sub>OH</sub>	Output HIGH Voltage	V <sub>DD</sub> = Min., V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -1mA	2	—		—
			I <sub>OH</sub> = -8mA	1.8 <sup>(3)</sup>	—		—
V <sub>OL</sub>	Output LOW Voltage	V <sub>DD</sub> = Min., V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 1mA	—	—		0.4
			I <sub>OL</sub> = 8mA	—	—	0.6	

**Notes:**

- For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at V<sub>DD</sub> = 2.5V, +25°C ambient and maximum loading.
- V<sub>OH</sub> = V<sub>DD</sub> - 0.6V at rated current.
- This value is limited to 3.6V maximum.

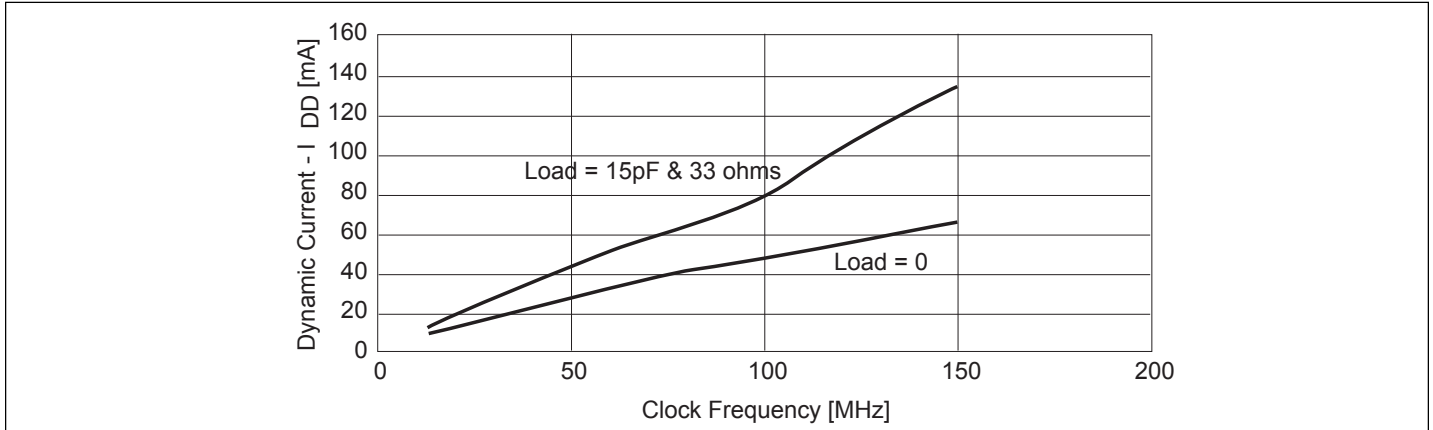
### Power Supply Characteristics

Parameters	Description	Test Conditions <sup>(1)</sup>	Min.	Typ. <sup>(2)</sup>	Max.	Units
I <sub>DDQ</sub>	Quiescent Power Supply Current	V <sub>DD</sub> = Max.		0.1	20	μA
ΔI <sub>DD</sub>	Supply Current per Inputs @ TTL HIGH	V <sub>DD</sub> = Max.		47	300	
I <sub>DD</sub>	Dynamic Supply Current (See Graph 1)	V <sub>DD</sub> = 2.7V, 15pF & 33-ohm load		136	—	mA

**Notes:**

- For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device.
- Typical values are at V<sub>DD</sub> = 2.5V, +25°C ambient.
- Per TTL driven input (V<sub>I</sub> = V<sub>DD</sub> - 0.6V); all other inputs at V<sub>I</sub> or GND.

Graph 1. Dynamic Current vs. Clock Frequency



Capacitance (T<sub>A</sub> = 25°C, f = 1 MHz)

Parameters <sup>(1)</sup>	Description	Test Conditions	Typ.	Max.	Units
C <sub>IN</sub>	Input Capacitance	V <sub>IN</sub> = 0V	3	4	pF
C <sub>OUT</sub>	Output Capacitance	V <sub>OUT</sub> = 0V		6	

Note:

1. This parameter is determined by device characterization but is not production tested.

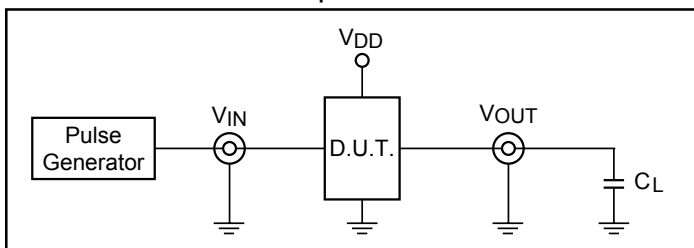
Switching Characteristics (V<sub>DD</sub> = 2.5V ± 0.2V, T<sub>A</sub> = 85°C)

Parameters	Description	Test Conditions <sup>(1)</sup>	Min.	Typ.	Max.	Units
t <sub>R</sub> /t <sub>F</sub>	CLK <sub>n</sub> Rise/Fall Time 0.7V ~ 1.7 V	C <sub>L</sub> = 22pF, 100 MHz	–	1.0	1.25	ns
		C <sub>L</sub> = 12pF, 150 MHz	–	1.0	1.2	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay BUF_IN to CLK <sub>n</sub>	C <sub>L</sub> = 22pF, 100 MHz	–	3.0	3.5	ns
		C <sub>L</sub> = 12pF, 150 MHz	–	2.4	2.7	
t <sub>SK(o)</sub> <sup>(2)</sup>	Skew between two outputs of the same package (same transition)	C <sub>L</sub> = 22pF, 100 MHz	–	100	150	ps
		C <sub>L</sub> = 12pF, 150 MHz	–	100	150	
t <sub>SK(p)</sub> <sup>(2)</sup>	Skew between opposite transitions (t <sub>PHL</sub> - t <sub>PLH</sub> ) of the same output	C <sub>L</sub> = 22pF, 100 MHz	–	250	300	ps
		C <sub>L</sub> = 12pF, 150 MHz	–	250	300	
t <sub>SK(t)</sub> <sup>(2)</sup>	Skew between two outputs of different package <sup>(4)</sup>	C <sub>L</sub> = 12pF, 150 MHz	–	400	600	ps

Notes:

1. See test circuit and waveforms.
2. Skew measured at worse case temperature (max. temp).

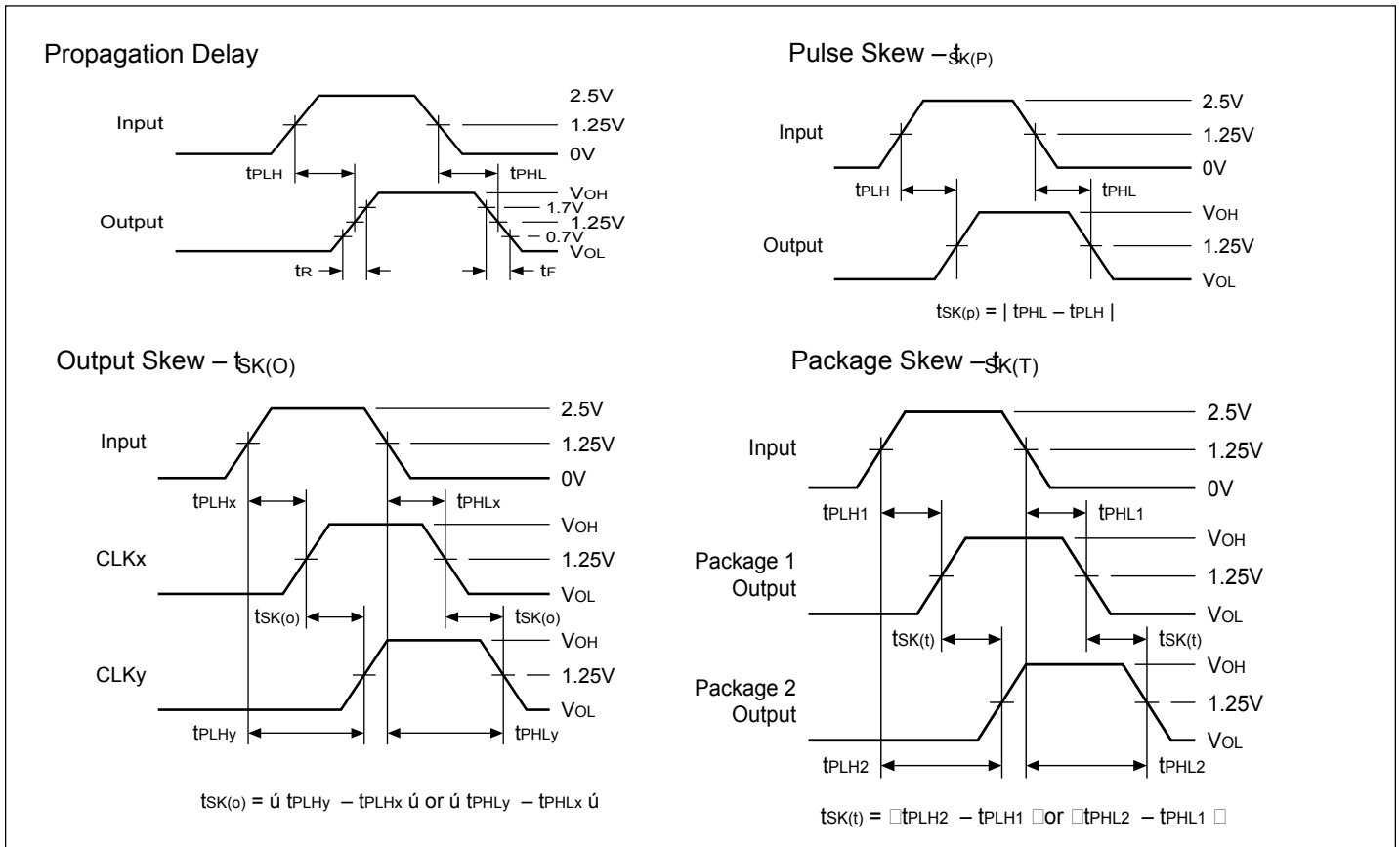
Test Circuits for All Outputs



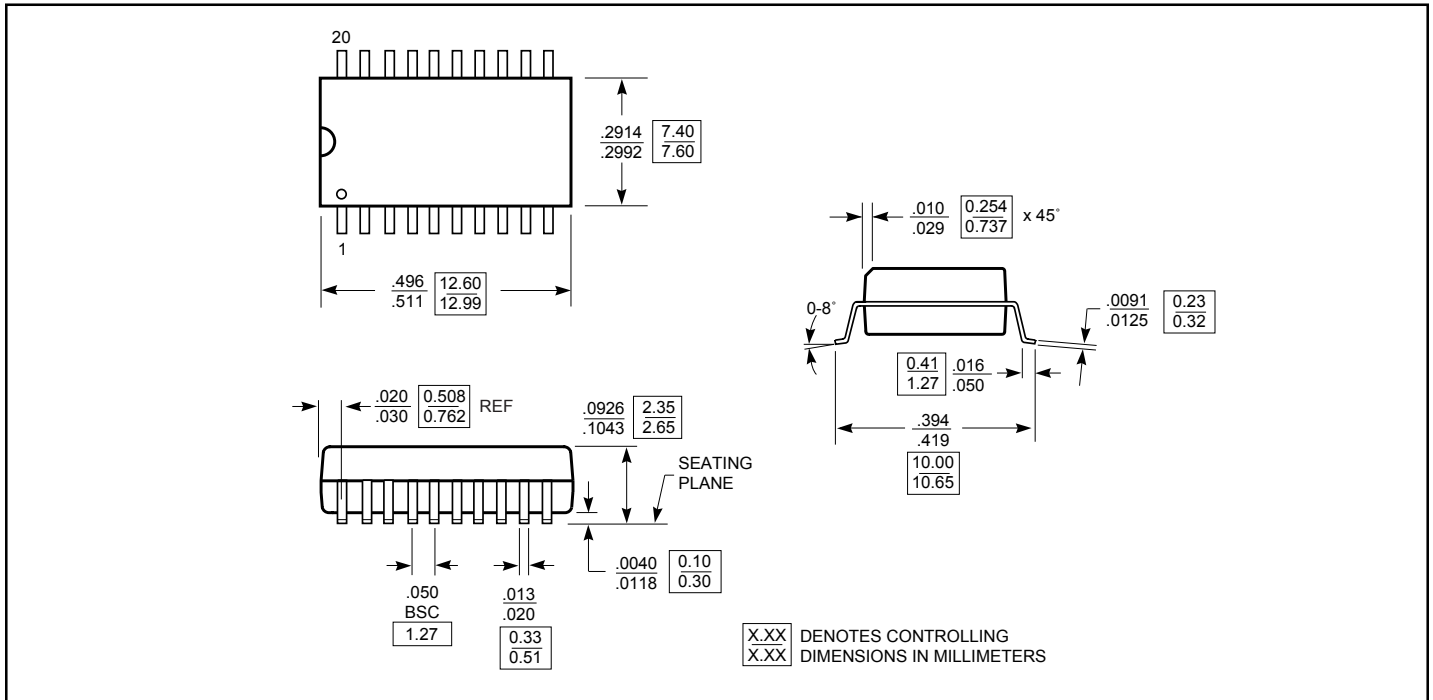
Definitions:

C<sub>L</sub> = Load capacitance: includes jig and probe capacitance.

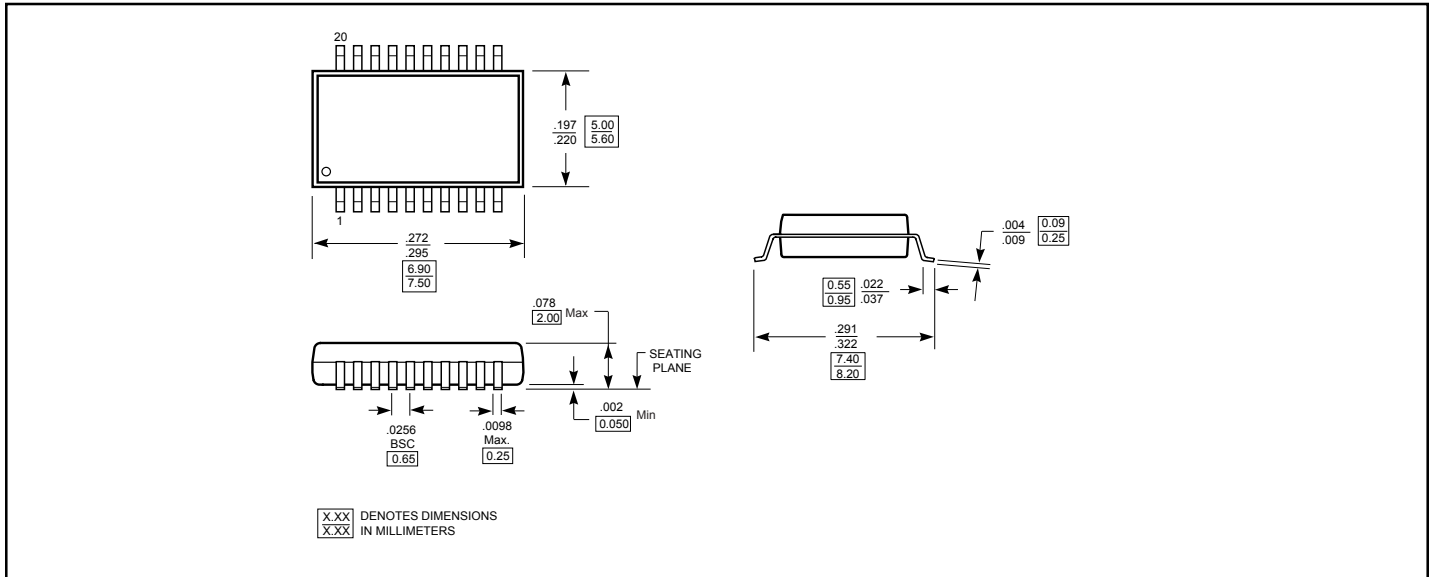
## Switching Waveforms



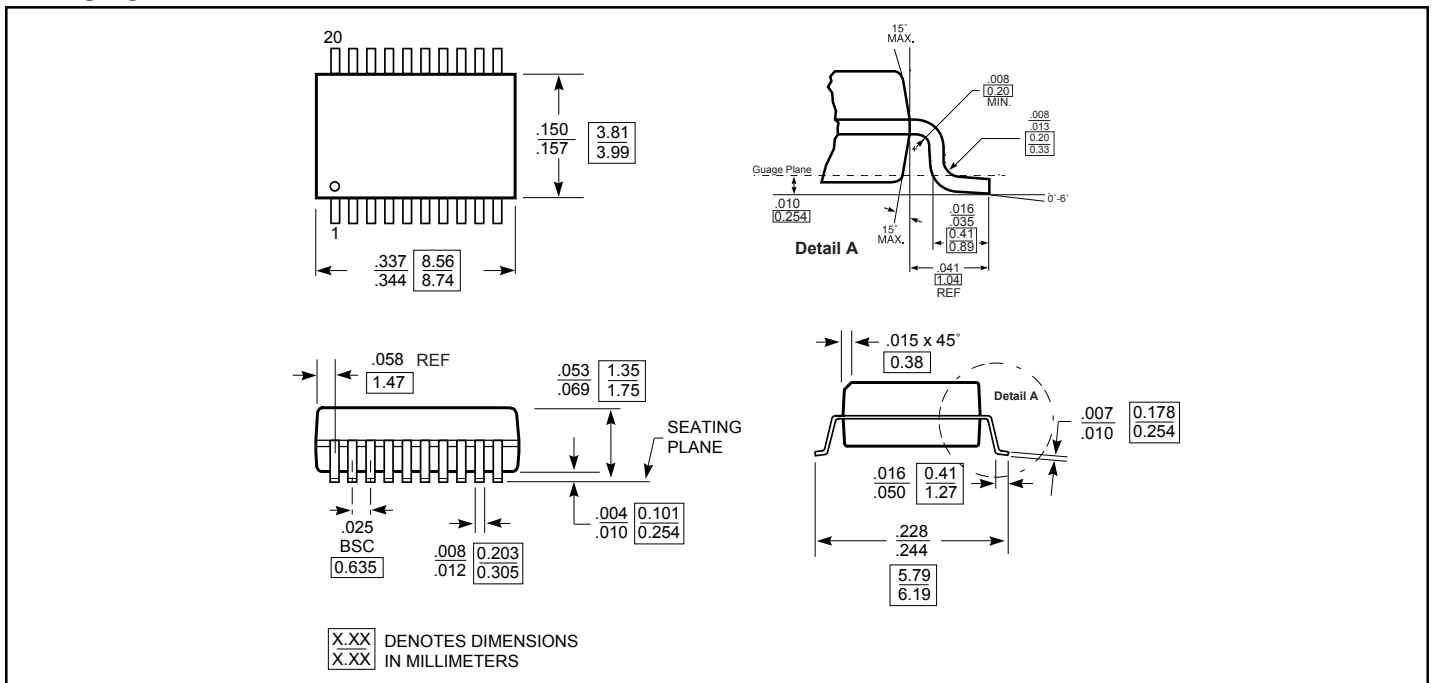
## Packaging Mechanical: 20-Pin SOIC (S)



Packaging Mechanical: 20-Pin SSOP (H)



Packaging Mechanical: 20-Pin QSOP (Q)





### Ordering Information

Ordering Code	PackageCode	PackageType
PI49FCT20807SE	S	Pb-free & Green, 20-pin 300-mil wide SOIC
PI49FCT20807QE	Q	Pb-free & Green, 20-pin 150-mil wide QSOP
PI49FCT20807HE	H	Pb-free & Green, 20-pin 209-mil wide SSOP

Notes:

1. Thermal characteristics can be found on the company web site at [www.pericom.com/packaging/](http://www.pericom.com/packaging/)